

CMOS Low Voltage 4 Ω Dual SPDT Switch

ADG736

FEATURES

+1.8 V to +5.5 V Single Supply 2.5 Ω (Typ) On Resistance Low On-Resistance Flatness -3 dB Bandwidth >200 MHz Rail-to-Rail Operation 10-Lead μ SOIC Package Fast Switching Times t_{ON} 16 ns t_{OFF} 8 ns Typical Power Consumption (<0.01 μ W) TTL/CMOS Compatible

APPLICATIONS

Battery Powered Systems Communication Systems Sample-and-Hold Systems Audio Signal Routing Audio and Video Switching Mechanical Reed Relay Replacement

FUNCTIONAL BLOCK DIAGRAM



SWITCHES SHOWN FOR A LOGIC "1" INPUT

GENERAL DESCRIPTION

The ADG736 is a monolithic device comprising two independently selectable CMOS SPDT switches. These switches are designed on a submicron process that provides low power dissipation yet gives high switching speed, low on resistance, low leakage currents and wide input signal bandwidth.

The on resistance profile is very flat over the full analog signal range. This ensures excellent linearity and low distortion when switching audio signals. Fast switching speed also makes the part suitable for video signal switching.

The ADG736 can operate from a single +1.8 V to +5.5 V supply, making it ideally suited to portable and battery powered instruments.

Each switch conducts equally well in both directions when on and has an input signal range that extends to the power supplies. The ADG736 exhibits break-before-make switching action.

The ADG736 is available in a 10-lead µSOIC package.

PRODUCT HIGHLIGHTS

- +1.8 V to +5.5 V Single Supply Operation. The ADG736 offers high performance, including low on resistance and fast switching times and is fully specified and guaranteed with +3 V and +5 V supply rails.
- 2. Very Low R_{ON} (4.5 Ω Max at 5 V, 8 Ω Max at 3 V). At supply voltage of +1.8 V, R_{ON} is typically 35 Ω over the temperature range.
- 3. Low On-Resistance Flatness.
- 4. -3 dB Bandwidth >200 MHz.
- Low Power Dissipation. CMOS construction ensures low power dissipation.
- 6. Fast t_{ON}/t_{OFF}.
- 7. Break-Before-Make Switching Action.
- 8. 10-Lead µSOIC Package.

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices.

$\label{eq:addition} ADG736 - SPECIFICATIONS^{1} (V_{DD} = +5 \ V \pm 10\%, \ \text{GND} = 0 \ \text{V}. \ \text{All Specifications} - 40^{\circ}\text{C} \ \text{to} \ +85^{\circ}\text{C}, \ \text{unless otherwise} \ \text{noted.} \\$

	B Version -40°C to			
Parameter	+25°C	+85°C	Units	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		0 V to V_{DD}	V	
On-Resistance (R _{ON})	2.5		Ω typ	$V_{S} = 0 V$ to V_{DD} , $I_{DS} = -10 mA$;
	4	4.5	Ω max	Test Circuit 1
On-Resistance Match Between				
Channels (ΔR_{ON})		0.1	Ω typ	$V_{S} = 0$ V to V_{DD} , $I_{DS} = -10$ mA
		0.4	Ω max	
On-Resistance Flatness (R _{FLAT(ON)})	0.5		Ω typ	$V_{S} = 0 V$ to V_{DD} , $I_{DS} = -10 mA$
		1.2	Ω max	
LEAKAGE CURRENTS				V _{DD} = +5.5 V
Source OFF Leakage I _S (OFF)	±0.01		nA typ	$V_{DD} = 13.3 V$ $V_{S} = 4.5 V/1 V, V_{D} = 1 V/4.5 V;$
Source OII Leanage 15 (OII)	± 0.01 ± 0.1	±0.3	nA max	$v_{s} = 4.5 v/1 v_{t}, v_{D} = 1 v/4.5 v_{t}$ Test Circuit 2
Channel ON Leakage I _D , I _S (ON)	± 0.11 ± 0.01	10.5	nA typ	$V_{s} = V_{D} = 1 V \text{ or } 4.5 V;$
Channel OIV Leakage $I_{\rm D}$, $I_{\rm S}$ (OIV)	± 0.01 ± 0.1	±0.3	nA max	Test Circuit 3
	±0.1	±0.5		
DIGITAL INPUTS				
Input High Voltage, V _{INH}		2.4	V min	
Input Low Voltage, V _{INL}		0.8	V max	
Input Current				
I _{INL} or I _{INH}	0.005		μA typ	$V_{IN} = V_{INL}$ or V_{INH}
		± 0.1	μA max	
DYNAMIC CHARACTERISTICS ²				
t _{ON}	12		ns typ	$R_L = 300 \Omega, C_L = 35 pF$
		16	ns max	$V_s = 3 V$, Test Circuit 4
t _{OFF}	5		ns typ	$R_{L} = 300 \Omega, C_{L} = 35 pF$
		8	ns max	$V_s = 3 V$, Test Circuit 4
Break-Before-Make Time Delay, t _D	7		ns typ	$R_{L} = 300 \Omega, C_{L} = 35 pF$
		1	ns min	$V_{S1} = V_{S2} = 3 V$, Test Circuit 5
Off Isolation	-62		dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$
	-82		dB typ	$R_{L} = 50 \Omega, C_{L} = 5 pF, f = 1 MHz;$
	-			Test Circuit 6
Channel-to-Channel Crosstalk	-62		dB typ	$R_{L} = 50 \Omega, C_{L} = 5 pF, f = 10 MHz$
	-82		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz;$
			uz typ	Test Circuit 7
Bandwidth –3 dB	200		MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; Test Circuit 8
C _s (OFF)	9		pF typ	
$C_{\rm D}, C_{\rm S}$ (ON)	32		pF typ	
POWER REQUIREMENTS				V _{DD} = +5.5 V
OWER REQUIREMENTS				$v_{DD} - +5.5 v$ Digital Inputs = 0 V or 5 V
I _{DD}	0.001		μA typ	
TDD	0.001	1.0		
		1.0	μA max	

NOTES

 $^{1}Temperature$ ranges are as follows: B Version: –40 $^{\circ}C$ to +85 $^{\circ}C.$

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

ADG736

SPECIFICATIONS¹ ($v_{DD} = +3 V \pm 10\%$, GND = 0 V. All Specifications -40°C to +85°C, unless otherwise noted.)

	B Version				
Parameter	+25°C	-40°C to +85°C	Units	Test Conditions/Comments	
ANALOG SWITCH					
Analog Signal Range		0 V to V_{DD}	v		
On-Resistance (R_{ON})	5	5.5	Ω typ	$V_{S} = 0 V \text{ to } V_{DD}, I_{DS} = -10 \text{ mA};$	
		8	Ω max	Test Circuit 1	
On-Resistance Match Between					
Channels (ΔR_{ON})	0.1		Ω typ	$V_{\rm S}$ = 0 V to $V_{\rm DD}$, $I_{\rm DS}$ = -10 mA	
		0.4	Ω max		
On-Resistance Flatness (R _{FLAT(ON)})		2.5	Ω typ	$V_{\rm S}$ = 0 V to $V_{\rm DD}$, $I_{\rm DS}$ = -10 mA	
LEAKAGE CURRENTS				$V_{DD} = +3.3 V$	
Source OFF Leakage I _S (OFF)	±0.01		nA typ	$V_{\rm S} = 3 \text{ V}/1 \text{ V}, V_{\rm D} = 1 \text{ V}/3 \text{ V};$	
	±0.1	± 0.3	nA max	Test Circuit 2	
Channel ON Leakage I _D , I _S (ON)	±0.01		nA typ	$V_{\rm S} = V_{\rm D} = 1 \text{ V or } 3 \text{ V;}$	
	±0.1	±0.3	nA max	Test Circuit 3	
DIGITAL INPUTS					
Input High Voltage, V _{INH}		2.0	V min		
Input Low Voltage, V _{INL}		0.4	V max		
Input Current					
I _{INL} or I _{INH}	0.005		μA typ	$V_{IN} = V_{INL}$ or V_{INH}	
		± 0.1	μA max		
DYNAMIC CHARACTERISTICS ²					
t _{ON}	14		ns typ	$R_{\rm L} = 300 \ \Omega, C_{\rm L} = 35 \ \rm pF$	
		20	ns max	$V_s = 2 V$; Test Circuit 4	
t _{OFF}	6		ns typ	$R_L = 300 \Omega, C_L = 35 pF$	
		10	ns max	$V_{\rm S}$ = 2 V; Test Circuit 4	
Break-Before-Make Time Delay, t _D	7		ns typ	$R_{L} = 300 \Omega, C_{L} = 35 pF$	
		1	ns min	$V_{S1} = V_{S2} = 2 V$; Test Circuit 5	
Off Isolation	-62		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$	
	-82		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz;$	
				Test Circuit 6	
Channel-to-Channel Crosstalk	-62		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$	
	-82		dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; Test Circuit 7	
Bandwidth –3 dB	200		MHz typ	$R_{\rm L} = 50 \Omega, C_{\rm L} = 5 \text{ pF; Test Circuit 8}$	
C _s (OFF)	9		pF typ		
$C_{\rm D}, C_{\rm S}$ (ON)	32		pF typ		
POWER REQUIREMENTS				$V_{DD} = +3.3 V$	
-				Digital Inputs = $0 \text{ V or } 3 \text{ V}$	
I _{DD}	0.001		μA typ		
		1.0	µA max		

NOTES ¹Temperature ranges are as follows: B Version: -40°C to +85°C.

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

ADG736

ABSOLUTE MAXIMUM RATINGS¹

$(T_A = +25^{\circ}C \text{ unless otherwise noted})$	
---	--

$(1_A - +2)$ C unless otherwise noted)
V_{DD} to GND0.3 V to +6 V
Analog, Digital Inputs ² 0.3 V to V _{DD} + 0.3 V or
30 mA, Whichever Occurs First
Continuous Current, S or D 30 mA
Peak Current, S or D 100 mA
(Pulsed at 1 ms, 10% Duty Cycle Max)
Operating Temperature Range
Industrial (B Version)40°C to +85°C
Storage Temperature Range
Junction Temperature
μSOIC Package, Power Dissipation
θ_{JA} Thermal Impedance 205°C/W
Lead Temperature, Soldering
Vapor Phase (60 sec) +215°C
Infrared (15 sec) +220°C
ESD
NOTES

NOTES

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

²Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

ORDERING GUIDE

Model	Temperature Range	Brand ¹	Package Option ²
ADG736BRM	–40°C to +85°C	SAB	RM-10

NOTES

¹Brand = Due to small package size, these three characters represent the part number.

 2 RM = μ SOIC.

PIN CONFIGURATION (10-Lead μSOIC)

TERMINOLOGY

V _{DD}	Most positive power supply potential.
GND	Ground (0 V) reference.
S	Source terminal. May be an input or output.
D	Drain terminal. May be an input or output.
IN	Logic control input.
R _{ON}	Ohmic resistance between D and S.
ΔR_{ON}	On resistance match between any two channels i.e., $R_{ON}max-R_{ON}min$.
R _{FLAT(ON)}	Flatness is defined as the difference between the maximum and minimum value of on resis- tance as measured over the specified analog signal range.
I _S (OFF)	Source leakage current with the switch "OFF."
I_D , I_S (ON)	Channel leakage current with the switch "ON."
$V_D(V_S)$	Analog voltage on terminals D, S.
C _S (OFF)	"OFF" switch source capacitance.
C_D, C_S (ON)	"ON" switch capacitance.
t _{ON}	Delay between applying the digital control input and the output switching on. See Test Circuit 4.
t _{OFF}	Delay between applying the digital control input and the output switching off.
t _D	"OFF" time or "ON" time measured between the 90% points of both switches, when switch- ing from one address state to another. See Test Circuit 5.
Crosstalk	A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.
Off Isolation	A measure of unwanted signal coupling through an "OFF" switch.
Bandwidth	The frequency at which the output is attenuated by -3 dBs.
On Response	The frequency response of the "ON" switch.
On Loss	The voltage drop across the "ON" switch, seen on the On Response versus frequency plot as how many dBs the signal is away from 0 dB at very low frequencies.

Table I. Truth Table

Logic Switch A		Switch B	
0	OFF	ON	
1	ON	OFF	

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG736 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Typical Performance Characteristics–ADG736



Figure 1. On Resistance as a Function of V_D (V_S) Single Supplies



Figure 2. On Resistance as a Function of V_D (V_S) for Different Temperatures $V_{DD} = 3 V$



Figure 3. On Resistance as a Function of V_D (V_S) for Different Temperatures $V_{DD} = 5 V$



Figure 4. Supply Current vs. Input Switching Frequency



Figure 5. On Response vs. Frequency



Figure 6. Off Isolation vs. Frequency

ADG736



Figure 7. Crosstalk vs. Frequency

APPLICATIONS



Figure 8. Using the ADG736 to Select Between Two Video Signals

I_D (ON)

Test Circuits



Test Circuit 1. On Resistance





Test Circuit 3. On Leakage







Test Circuit 5. Break-Before-Make Time Delay, t_D



Test Circuit 6. Off Isolation



CHANNEL-TO-CHANNEL CROSSTALK = $20 \times \log |V_S/V_{OUT}|$





Test Circuit 8. Bandwidth

OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

10-Lead μSOIC (RM-10)

